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Product Change Notification - CYER-01DNRB151

Date: 18 Jan 2011

Product Category: 16-bit Microcontrollers and Digital Signal Controllers; Analog (Linear & Mixed Signal) AND Interface; RF and Security; Touch Sensing T

8-bit Microcontrollers; All 16-bit Microcontrollers

Device Family:

7

Notification subject: CCB# 946 Qualification of different paddle sizes in 18L & 28L SOIC packages at MMS (ATES).

Notification text:

PCN Status: Final notification

Note: The 28L SOIC package qualification was completed and the PCN issued with attached qualific on 6/28/2010. This notification includes the qualification report for the 18L SOIC package qualification

Microchip Part#s Affected:

See attachments of Affected Part Numbers Labeled as...

PCN# CYER-01DNRB151_Affected_CPN.xls PCN# CYER-01DNRB151_Affected_CPN.pdf

Description of Change:

Qualification of an different paddle size in 18L & 28L SOIC packages at MMS (ATES).

Pre Change:

18L SOIC: 160 x 200 mils paddle 28L SOIC: 160 x 205 mils paddle

Post Change:

18L SOIC: 140 x 170 mils paddle 28L SOIC: 200 x 240 mils paddle

Impacts to Data Sheet:

None

Reason for Change:

To improve manufacturability

Change Implementation Status:

In Progress

Estimated First Ship Date:

28L SOIC: October 31, 2010 (Date code 1044) - see PCN revision history below

18L SOIC: February 28, 2011 (Date code 1110)

NOTE: Please be advised that during the transition period customers may receive pre and post chardue to existing inventory of the pre changed parts.

Markings to Distinguish Revised from Unrevised Devices:

Traceability code

PCN CYER-01DNRB151 Revision History:

April 1, 2010: Initial notification issued

June 28, 2010: Intermediate notification issued, which includes an attached qualification report and ϵ first ship date of 10/31/2010 for the 28L SOIC package.

January 18, 2011: Final notification issued, which includes all of the above information and the additi attached qualification report and estimated first ship date of 2/28/2011 for the 18L SOIC package.

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Attachment(s): PCN_CYER-01DNRB151_Affected_CPN.pdf

PCN_CYER-01DNRB151_Affected_CPN.xls
PCN_CYER-01DNRB151_Qual Report_18L.pdf
PCN_CYER-01DNRB151_Qual Report_28L.pdf

Please contact your local Microchip sales office with questions or concerns regarding this notification.

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CYER-01DNRB151 - CCB# 946 Qualification of different paddle sizes in 18L & 28L SOIC packages at MMS (ATES). Parts Affected dsPIC30F2010 dsPIC30F2011 dsPIC30F2012 dsPIC33FJ12GP201 dsPIC33FJ12GP202 dsPIC33FJ12MC202 dsPIC33FJ32GP202 dsPIC33FJ32MC202 ENC28J60 HCS512 HS10-100S0s/10SS25MCP2140 MCP2140A MCP2150 MCP2155 MCP23009 MCP23016 MCP23017 MCP23018 MCP23S09 MCP23S17

MCP23S18 MCP2510 MCP2515 PIC16C54 PIC16C54A PIC16C55 PIC16C554 PIC16C558 PIC16C55A PIC16C56 PIC16C56A PIC16C57 PIC16C57C PIC16C58B PIC16C620 PIC16C620A PIC16C621 PIC16C621A PIC16C622 PIC16C622A PIC16C62A PIC16C62B PIC16C63

Date: Wednesday, January 19, 2011

CYER-01DNRB151 - CCB# 946 Qualification of different paddle sizes in 18L & 28L SOIC packages at MMS (ATES). PIC16C63A PIC16C71 PIC16C710 PIC16C711 PIC16C712 PIC16C715 PIC16C716 PIC16C717 PIC16C72 PIC16C72A PIC16C73A PIC16C73B PIC16C773 PIC16CR54A PIC16CR57C PIC16CR58B PIC16CR620A PIC16CR72 PIC16CR83 PIC16F1826 PIC16F1827 PIC16F1933 PIC16F1936 PIC16F1938 PIC16F57 PIC16F627 PIC16F627A PIC16F628 PIC16F628A PIC16F648A PIC16F72 PIC16F722 PIC16F723 PIC16F726 PIC16F73 PIC16F737 PIC16F76 PIC16F767 PIC16F83 PIC16F84 PIC16F84A PIC16F87 PIC16F870 PIC16F872 PIC16F873A PIC16F876A

Date: Wednesday, January 19, 2011

CYER-01DNRB151 - CCB# 946 Qualification of different paddle sizes in 18L & 28L SOIC packages at MMS (ATES). PIC16F88 PIC16F882 PIC16F883 PIC16F886 PIC16F913 PIC16F916 PIC16HV540 PIC18F1220 PIC18F1230 PIC18F1320 PIC18F1330 PIC18F14K22 PIC18F2221 PIC18F2321 PIC18F23K20 PIC18F2420 PIC18F2423 PIC18F2450 PIC18F24J11 PIC18F24J50 PIC18F24K20 PIC18F2510 PIC18F2520 PIC18F2523 PIC18F25J11 PIC18F25J50 PIC18F25K20 PIC18F25K22 PIC18F26J11 PIC18F26J50 PIC18F26K20 PIC24F08KA102 PIC24F16KA102 PIC24FJ16GA002 PIC24FJ32GA002 PIC24FJ32GA102 PIC24FJ32GB002 PIC24FJ48GA002 PIC24FJ64GA002 PIC24FJ64GA102 PIC24FJ64GB002 PIC24HJ12GP201 PIC24HJ12GP202 PIC24HJ32GP202 TC514

Date: Wednesday, January 19, 2011